

# ULTRA PRECISION 8:1 MUX WITH INTERNAL TERMINATION AND 1:2 CML FANOUT BUFFER

Precision Edge<sup>®</sup> SY58037U

#### **FEATURES**

- Selects between 1 of 8 inputs, and provides two precision, low skew CML output copies
- Guaranteed AC performance over temperature and voltage:
  - DC to 5Gbps throughput
  - <450ps propagation delay IN-to-Q (V<sub>IN</sub> ≥ 300mV)
  - <70ps t<sub>r</sub> / t<sub>f</sub> time
  - <15ps skew (output-to-output)</li>
- Unique, patent-pending, channel-to-channel isolation design provides superior crosstalk performance
- Ultra-low jitter design:
  - <1ps<sub>RMS</sub> random jitter
  - <10ps<sub>PP</sub> deterministic jitter
  - <10ps<sub>pp</sub> total jitter (clock)
  - <0.7ps<sub>RMS</sub> crosstalk-induced jitter
- Unique, patent-pending, input termination and VT pin accepts DC- and AC-coupled inputs (CML, PECL, LVDS)
- 400mV CML output swing
- 50 $\Omega$  source terminated outputs minimize round-trip reflections
- Power supply 2.5V ±5% or 3.3V ±10%
- -40°C to +85°C temperature range
- Available in 44-pin (7mm × 7mm) MLF<sup>TM</sup> package

#### **APPLICATIONS**

- Data communication systems
- All SONET/SDH data/clock applications
- All Fibre Channel applications
- All Gigabit Ethernet applications



Precision Edge<sup>®</sup>

#### **DESCRIPTION**

The SY58037U is a low jitter, low skew, high-speed 8:1 multiplexer with a 1:2 differential fanout buffer optimized for precision telecom and enterprise server distribution applications. The SY58037U distributes clock frequencies from DC to 4GHz and data rates to 5Gpbs guaranteed over temperature and voltage.

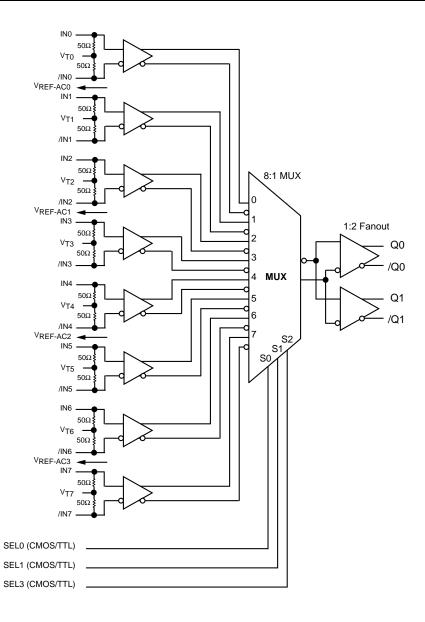
The SY58037U differential input includes Micrel's unique, 3-pin input termination architecture that directly interfaces to any differential signal (AC- or DC-coupled) as small as 100mV (200mVpp) without any level shifting or termination resistor networks in the signal path. The outputs are  $50\Omega$  source-terminated CML with extremely fast rise/fall time guaranteed to be less than 70ps.

The SY58037U features a patent-pending isolation design that significantly improves channel-to-channel crosstalk performance.

The SY58037U operates from a 2.5V  $\pm$ 5% or 3.3V  $\pm$ 10% supply and is guaranteed over the full industrial temperature range of  $-40^{\circ}$ C to  $+85^{\circ}$ C. The SY58037U is part of Micrel's high-speed, Precision Edge® product line.

Data sheets and support documentation can be found on Micrel's web site at www.micrel.com.

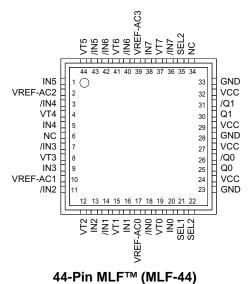
## **FUNCTIONAL BLOCK DIAGRAM**



## **TRUTH TABLE**

SEL2	SEL1	SEL0	Q	/Q
L	L	L	IN0	/INO
L	L	Ι	IN1	/IN1
L	Н	L	IN2	/IN2
L	Н	Н	IN3	/IN3
Н	L	L	IN4	/IN4
Н	L	Н	IN5	/IN5
Н	Н	L	IN6	/IN6
Н	Н	Н	IN7	/IN7

## **PACKAGE/ORDERING INFORMATION**



# Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58037UMI	MLF-44	Industrial	SY58037U	Sn-Pb
SY58037UMITR <sup>(2)</sup>	MLF-44	Industrial	SY58037U	Sn-Pb
SY58037UMG	MLF-44	Industrial	SY58037U with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY58037UMGTR <sup>(2)</sup>	MLF-44	Industrial	SY58037U with Pb-Free bar-line indicator	Pb-Free NiPdAu

#### Notes:

- 1. Contact factory for die availability. Dice are guaranteed at  $T_A = 25$ °C, DC electricals only.
- 2. Tape and Reel.

### **PIN DESCRIPTION**

Pin Number	Pin Name	Pin Function
20, 18, 16, 14, 13, 11, 9, 7, 5, 3, 1, 43, 42, 40, 38, 36	IN0, /IN0, IN1, /IN1, IN2, /IN2, IN3, /IN3, IN4, /IN4, IN5,/IN5, IN6, /IN6, IN7, /IN7	Differential Inputs: These input pairs are the differential signal inputs to the device. Inputs accept AC or DC-coupled signals as small as 100mV. Each pin of a pair internally terminates to a VT pin through $50\Omega$ . Note that these inputs will default to an indeterminate state if left open. Please refer to the "Input Interface Applications" section for more details.
19,15, 12, 8, 4, 44, 41, 37	VT0, VT1 VT2, VT3, VT4, VT5, VT6, VT7	Input Termination Center-Tap: Each side of the differential input pair terminates to a VT pin. The VT pins provide a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section for more details.
17, 10, 2 39	VREF-AC0, VREF-AC1, VREF-AC2, VREF-AC3	Reference Voltage: This output biases to $V_{CC}$ –1.2V. It is used when AC coupling the inputs (IN, /IN). For AC-coupled applications, connect VREF_AC to the VT pin and bypass with a 0.01 $\mu$ F low ESR capacitor to $V_{CC}$ . See "Input Interface Applications" section for more details.
21, 22, 35	SEL0, SEL1, SEL2	The TTL/CMOS-compatible inputs select the inputs to the multiplexer. Note that this input is internally connected to a $25k\Omega$ pull-up resistor and will default to a logic HIGH state if left open.
24, 27, 29, 32	VCC	Positive Power Supply. Bypass with $0.1\mu F \mid 0.01\mu F$ low ESR capacitors as close to each VCC pin.
25, 26, 30, 31	Q0,/Q0, Q1,/Q1	Differential Outputs: These CML output pairs are the outputs of the device. Please refer to the truth table below for details. Unused output pairs may be left open. Each output is designed to drive $400 \text{mV}$ into $100 \Omega$ across each output pair.
23, 28, 33	GND, Exposed Pad	Ground. GND and exposed pad must both be connected to the most negative potential of chip ground.

## **Absolute Maximum Ratings**(1)

Power Supply Voltage (V <sub>CC</sub> )	0.5V to +4.0V
Input Voltage (V <sub>IN</sub> )	–0.5V to V <sub>CC</sub>
LVPECL Output Current (I <sub>OUT</sub> )	
Continuous	50mA
Surge	100mA
Termination Current <sup>(3)</sup>	
Source or sink current on VT pin	±100mA
Lead Temperature (soldering, 20 sec.)	260°C
Storage Temperature Range (T <sub>S</sub> )	–65°C to +150°C

# Operating Ratings<sup>(2)</sup>

Power Supply Voltage (V <sub>CC</sub> )	. +2.375V to +2.625V
	+3.0V to +3.6V
Ambient Temperature Range (T <sub>A</sub> )	40°C to +85°C
Package Thermal Resistance(4)	
$MLF^{TM}$ $(\theta_{JA})$	
Still-Air	24°C/W
MLF™ (Ψ <sub>JB</sub> )	
Junction-to-board	12°C/W

## DC ELECTRICAL CHARACTERISTICS(5)

 $T_A = -40$ °C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>CC</sub>	Power Supply Voltage	V <sub>CC</sub> = 2.5V.	2.375	2.5	2.625	V
		V <sub>CC</sub> = 3.3V.	3.0	3.3	3.6	V
I <sub>CC</sub>	Power Supply Current	No load, max. V <sub>CC</sub> .		145	200	mA
R <sub>IN</sub>	Input Resistance (IN-to-V <sub>T</sub> )		40	50	60	Ω
R <sub>DIFF_IN</sub>	Differential Input Resistance (IN-to-/IN)		80	100	120	Ω
V <sub>IH</sub>	Input HIGH Voltage (IN-to-/IN)	Note 6	V <sub>CC</sub> -1.6		V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage (IN-to-/IN)		0		V <sub>IH</sub> -0.1	V
V <sub>IN</sub>	Input Voltage Swing (IN-to-/IN)	See Figure 1a.	0.1		1.7	V
V <sub>DIFF_IN</sub>	Differential Input Voltage Swing (IN-to-/IN)	See Figure 1b.	0.2			V
$\overline{V_{T_{\_IN}}}$	IN to V <sub>T</sub> (IN-to-/IN)				1.28	V
V <sub>REF-AC</sub>	Output Reference Voltage		V <sub>CC</sub> -1.3	V <sub>CC</sub> -1.2	V <sub>CC</sub> -1.1	V

#### Notes:

- 1. Permanent device damage may occur if ratings in the "Absolute Maximum Ratings" section are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Due to the limited drive capability, use for input of the same package only.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. Ψ<sub>JB</sub> uses 4-layer θ<sub>JA</sub> in still-air number unless otherwise stated.
- 5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- 6. V<sub>IH</sub> (min), not lower than 1.2V.

## CML OUTPUT DC ELECTRICAL CHARACTERISTICS<sup>(7)</sup>

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$  = -40°C to +85°C;  $R_L$  = 100 $\Omega$  across each output pair, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>OH</sub>	Output HIGH Voltage Q, /Q		V <sub>CC</sub> -0.040	V <sub>CC</sub> -0.010	V <sub>CC</sub>	V
V <sub>OUT</sub>	Output Differential Swing Q, /Q	See Figure 1a.	325	400		mV
V <sub>DIFF_OUT</sub>	Differential Output Voltage Swing Q, /Q	See Figure 1b.	650	800		mV
R <sub>OUT</sub>	Output Source Impedance		40	50	60	Ω

## LVTTL/CMOS DC ELECTRICAL CHARACTERISTICS<sup>(7)</sup>

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$ = -40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
$V_{IH}$	Input HIGH Voltage		2.0		V <sub>CC</sub>	V
$V_{IL}$	Input LOW Voltage				0.8	V
I <sub>IH</sub>	Input HIGH Current		-125		30	μА
I <sub>IL</sub>	Input LOW Current		-300			μА

#### Note:

7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

## AC ELECTRICAL CHARACTERISTICS(8)

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$ = -40°C to +85°C,  $R_L$  = 100 $\Omega$  across each output pair or equivalent, unless otherwise stated.

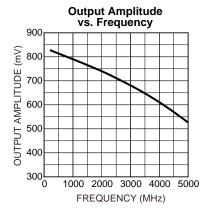
Symbol	Parameter	•	Condition	Min	Тур	Max	Units
f <sub>MAX</sub>	Maximum Operating Frequency		NRZ data Clock	5 4			Gbps GHz
t <sub>pd</sub>	Differential	Propagation Delay (IN-to-Q)	$V_{IN} \ge 100 \text{mV}$	240	35550	450	ps
		(SEL-to-Q)		100		550	ps
∆t <sub>pd</sub> Tempco	Differential Propagation Delay Temperature Coefficient				215		fs/°C
t <sub>SKEW</sub>		Output-to-Output Skew	Note 9			15	ps
		Part-to-Part Skew	Note 10			150	ps
t <sub>JITTER</sub>	Data	Random Jitter (RJ)	Note 11			1	ps <sub>RMS</sub>
		Deterministic Jitter (DJ)	Note 12			10	ps <sub>PP</sub>
·	Clock	Cycle-to-Cycle Jitter Total Jitter (TJ)	Note 13 Note 14			1 10	ps <sub>RMS</sub> ps <sub>PP</sub>
		Crosstalk-induced Jitter	Note 15			0.7	ps <sub>RMS</sub>
t <sub>r</sub> , t <sub>f</sub>	Output Rise/Fall Time		At full output swing, 20% to 80%.	20	40	70	ps

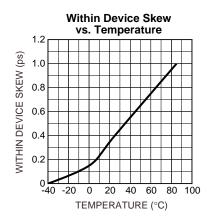
#### Notes:

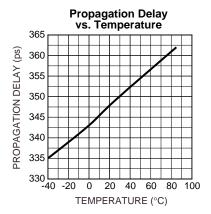
- 8. High-frequency AC-parameters are guaranteed by design and characterization.
- 9. Output-to-output skew is measured between two different outputs under identical input transitions.
- 10. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs
- 11. Random jitter is measured with a K28.7 character pattern, measured at  $\leq f_{MAX}$ .
- 12. Deterministic jitter is measured at 2.5Gbps/3.2Gbps, with both K28.5 and 2<sup>23</sup>–1 PRBS pattern.
- 13. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles,  $T_n T_{n-1}$  where T is the time between rising edges of the output signal.
- 14. Total jitter definition: with an ideal clock input of frequency ≤f<sub>MAX</sub>, no more than one output edge in 10<sup>12</sup> output edges will deviate by more than the specified peak-to-peak jitter value.
- 15. Crosstalk is measured at the output while applying two similar differential clock frequencies that are asynchronous with respect to each other adjacent inputs.

### **TYPICAL OPERATING CHARACTERISTICS**

 $V_{CC}$  = 3.3V, GND = 0,  $V_{IN}$  = 100mV,  $T_A$  = 25°C, unless otherwise stated.

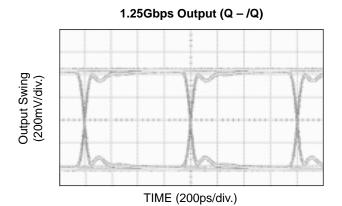






# **FUNCTIONAL CHARACTERISTICS**

 $\rm V_{CC}$  = 3.3V, GND = 0,  $\rm V_{IN}$  = 100mV,  $\rm T_A$  = 25°C, unless otherwise stated.

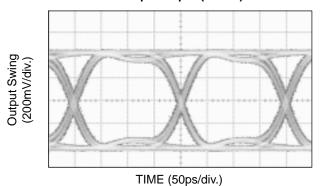


Output Swing (200mV/div.)

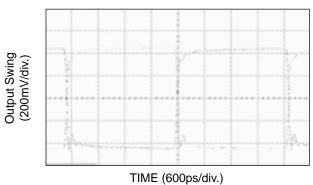
TIME (100ps/div.)

2.5Gbps Output (Q - /Q)

5Gbps Output (Q -/Q)

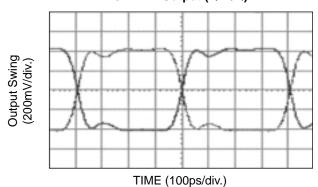


200MHz Output (Q - /Q)



` '

#### 622MHz Output (Q - /Q)



## **SINGLE-ENDED AND DIFFERENTIAL SWINGS**



Figure 1a. Single-Ended Voltage Swing

Figure 1b. Differential Voltage Swing

### **INPUT AND OUTPUT STAGES**

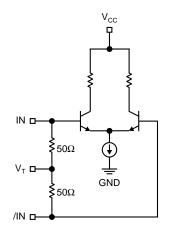


Figure 2a. Simplified Differential Input Stage

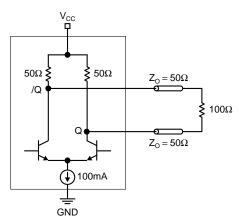


Figure 2b. CML DC-Coupled (100 $\Omega$  Termination)

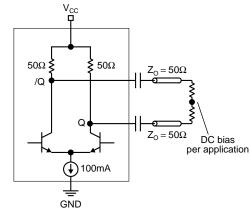


Figure 2c. CML AC-Coupled (50 $\Omega$  Termination)

### **INPUT INTERFACE APPLICATIONS**

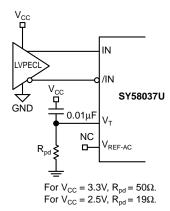


Figure 3a. LVPECL Interface (DC-Coupled)

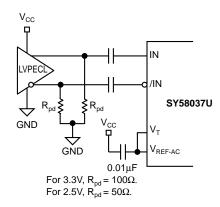
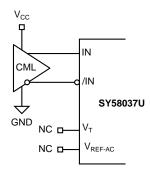


Figure 3b. LVPECL Interface (AC-Coupled)



Option: May connect  $V_T$  to  $V_{CC}$ .

Figure 3c. CML Interface (DC-Coupled)

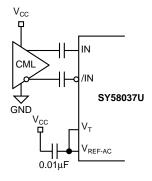


Figure 3d. CML Interface (AC-Coupled)

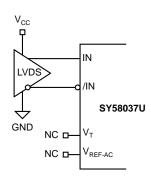
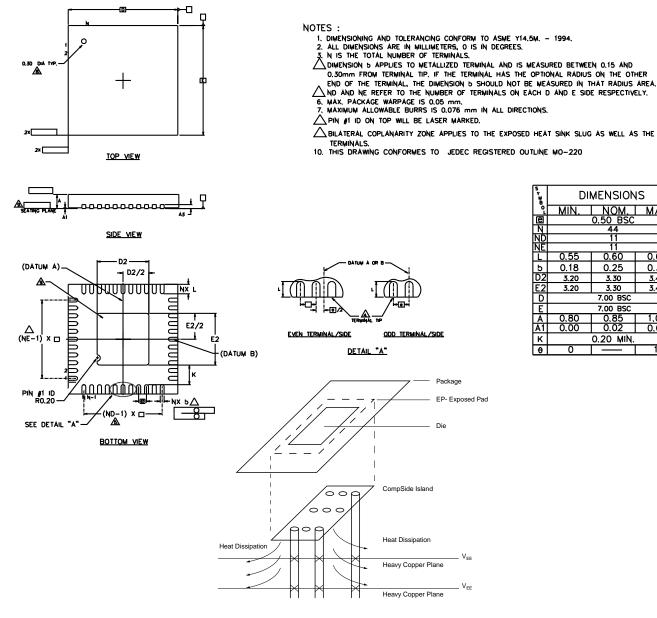


Figure 3e. LVDS Interface

### RELATED MICREL PRODUCTS AND SUPPORT DOCUMENTATION

Part Number	Function	Data Sheet Link
SY58037U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 CML Fanout Buffer	http://www.micrel.com/product-info/products/sy58037u.shtml
SY58038U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 LVPECL Fanout Buffer	http://www.micrel.com/product-info/products/sy58038u.shtml
SY58039U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 400mV LVPECL Fanout Buffer	http://www.micrel.com/product-info/products/sy58039u.shtml
	MLF™ Application Note	www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

#### LEAD *Micro*LeadFrame<sup>™</sup> (MLF-44)



DIMENSIONS NOM 0.65 0,60 0.30 0.18 0.25 3,30 3,40 3,30 7.00 BS 7.00 BSC 0.02 0.20 MIN

PCB Thermal Consideration for 44-Pin MLF™ Package (Always solder, or equivalent, the exposed pad to the PCB)

#### **Package Notes:**

- 1. Package meets Level 2 qualification.
- 2. All parts are dry-packaged before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

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